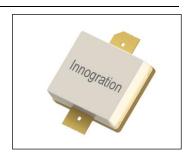
Document Number: ITGH09120A2C Preliminary Datasheet V1.0

120W,28V Sub-1GHz RF LDMOS Transistor

Description

The ITGH09120A2C is 120-watt, high performance, input matched LDMOS transistor, designed for any general applications within UHF up to 1GHz, in new generation highly cost effective open cavity package.



•Typical 915MHz Class AB RF Performance (On Innogration fixture with device soldered).

Vds=28V, Idq=10mA

Freq	P1dB	P1dB	P1dB	P1dB	P3dB	P3dB	P3dB	
(MHz)	(dBm)	(W)	Eff(%)	Gain(dB)	(dBm)	(W)	Eff(%)	
915	50.4	109.6	65. 2	20.85	51. 36	136.9	70	

Typical 758-803MHz Class AB RF Performance (On Innogration fixture with device soldered).
 Vds=28V, Idq=970mA

Freq	Pout	CCDF	Ppeak	Ppeak	ACPR	Gain	Efficiency
(MHz)	(dBm)	(dB)	(dBm)	(W)	(dBc)	(dB)	(%)
758	43.00	8. 54	51.54	142.7	-39.1	23.6	25. 6
780	43.00	8.40	51.40	138.0	-39.7	24. 3	27. 7
803	42.99	8. 13	51. 12	129.3	-39. 1	23.6	30. 1

Features

- High Efficiency and Linear Gain Operations
- Integrated ESD Protection
- Excellent thermal stability, low HCI drift
- Large Positive and Negative Gate/Source Voltage Range for Improved Class C Operation
- Pb-free, RoHS-compliant

Suitable Applications

- P band power amplifier
- All 4G/5G cellular application within 0.7 to 1GHz

Table 1. Maximum Ratings

Rating	Symbol	Value	Unit
DrainSource Voltage	V _{DSS}	+65	Vdc
GateSource Voltage	V_{GS}	-10 to +10	Vdc
Operating Voltage	V_{DD}	+28	Vdc
Storage Temperature Range	Tstg	-65 to +150	°C
Case Operating Temperature	Tc	+150	°C
Operating Junction Temperature	TJ	+225	°C

Table 2. Thermal Characteristics

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case	Do 10	0.65	0000
T _C = 85°C, DC test,	Rejc	0.65	°C/W



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Table 3. ESD Protection Characteristics

Test Methodology	Class
Human Body Model (per JESD22A114)	Class 2

Table 4. Electrical Characteristics (TA = 25 $^{\circ}$ C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
DC Characteristics	OC Characteristics				
Drain-Source Voltage	V _{(BR)DSS}		65		V
V _{GS} =0, I _{DS} =100uA	V (BR)DSS		00		V
Zero Gate Voltage Drain Leakage Current				4	^
$(V_{DS} = 28V, V_{GS} = 0 V)$	DSS	·		ı	μΑ
GateSource Leakage Current	1			1	^
$(V_{GS} = 11 \text{ V}, V_{DS} = 0 \text{ V})$	I _{GSS}			ı	μΑ
Gate Threshold Voltage	V _{GS} (th)		2		V
$(V_{DS} = 28V, I_D = 600 \mu A)$	V GS(III)		2		V
Gate Quiescent Voltage	$V_{GS(Q)}$		2.6		V
(V _{DD} = 28V, I _D = 600mA, Measured in Functional Test)	V GS(Q)		2.0		V

Load Mismatch (In Innogration Test Fixture, 50 ohm system): $V_{DD} = 28 Vdc$, $I_{DQ} = 600 mA$, f = 800 MHz

VSWR 10:1 at 120W pulse CW Output Power	No Device Degradation
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915MHz application board

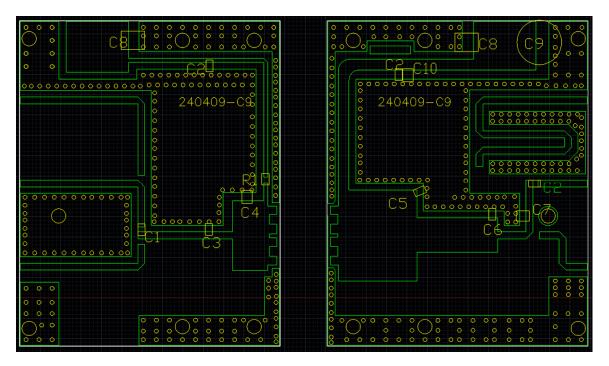


Figure 2. Test Circuit Component Layout, 30mils RO4350B

Note:

Table 5. Test Circuit Component Designations and Values

Component	Value	Quantity
C1	3pF	1
C2	30pF	3
R1	10 ohm	1
C3	4.7pF	1
C4	5.6pF	1
C5	10pF	1
C6	2.7pF	1
C7	3.9pF	1
C8	10uF	2
C10	1uF	1
C9	470uF	1



TYPICAL CHARACTERISTICS

Figure 3. Power Gain and Drain Efficiency as function of Power Output

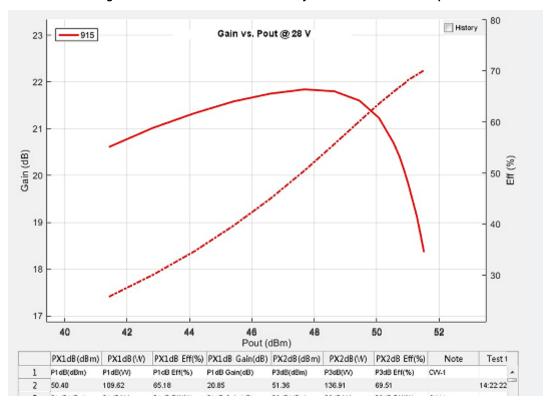
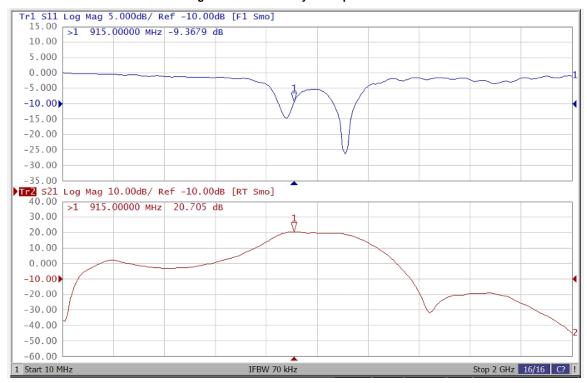


Figure 4. Network analyzer output S11/S21



758-803MHz application board

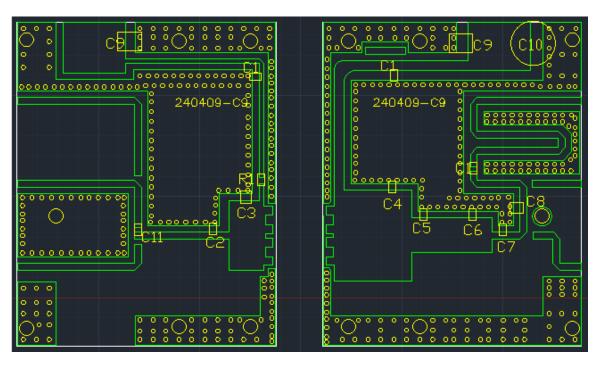


Figure 5. Test Circuit Component Layout, 20mils RO4350B

Note:

Table 6. Test Circuit Component Designations and Values

Component	Value	Quantity
C1	30pF	3
C2	8.2pF	1
R1	10 ohm	1
C3	12pF	1
C4	5.6pF	1
С9	10uF	2
C10	470uF	1
C5	10pF	1
C6	4.7pF	1
C7	0.8pF	1
C8	5.1pF	1
C11	3pF	1



TYPICAL CHARACTERISTICS

Figure 6. Power Gain and Drain Efficiency as function of Power Output

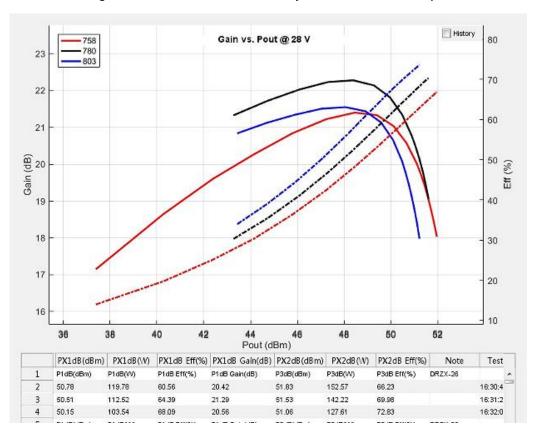


Figure 7: Network analyzer Output S11/S21





Package Dimensions

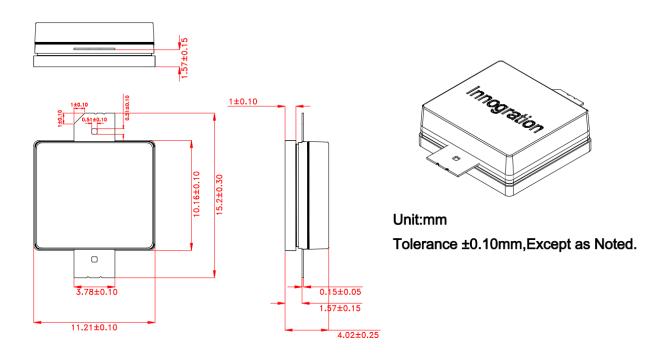


Table 7. Document revision history

Date	Revision	Datasheet Status
2024/5/31	Rev 1.0	Preliminary Datasheet

Application data based on ZXY-24-29/30

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